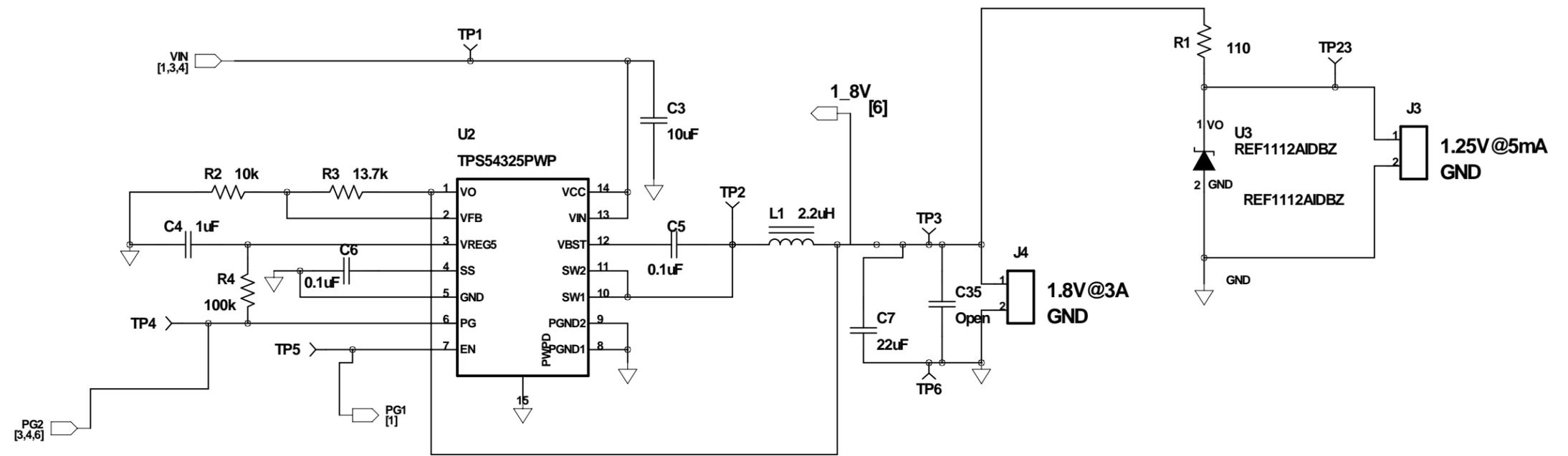


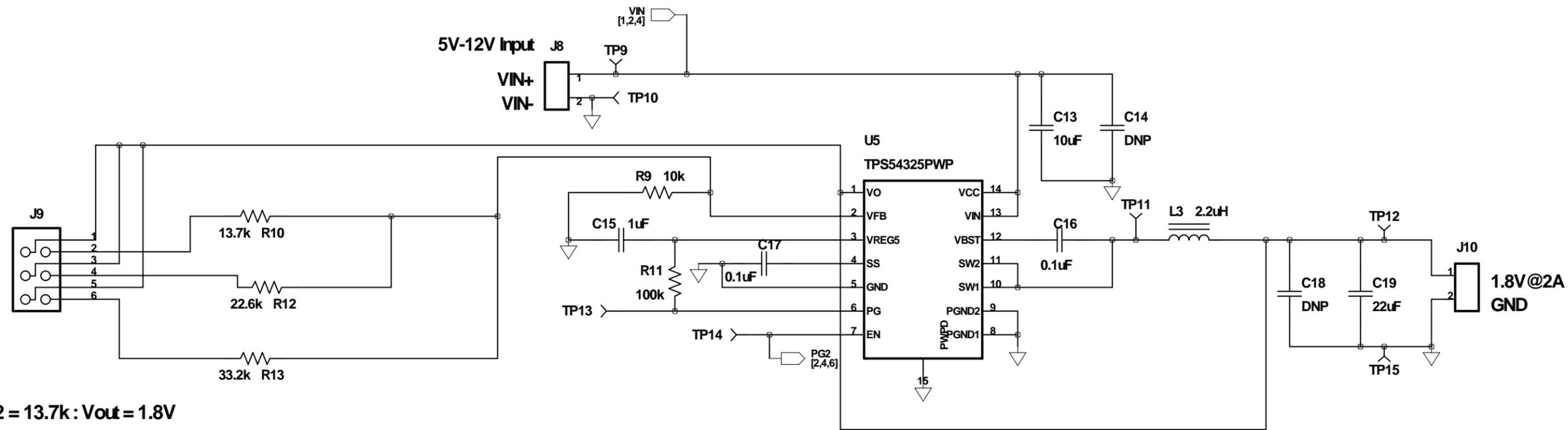
| | | |
|-------------------------------|---------------------------|---------------------------|
| Texas Instruments | | |
| Title Power for Zynq-7000 | | |
| Size B | Number PMP8251 | Rev B |
| Date 6/4/2013 | Engineer Sureena Gupta | Drawn by Sureena Gupta |
| Filename PMP8251_Rev_B.sch | Sheet 1 of 7 | 6/4/2013 |



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|-------------------------------|---------------------------|----------|
| Texas Instruments | | |
| Title Power for Zynq-7000 | | |
| Size B | Number PMP8251 | Rev B |
| Date 6/4/2013 | Drawn by Sureena Gupta | |
| Filename PMP8251_Rev_B.sch | Sheet 2 of 7 | |

Engineer Sureena Gupta

6/4/2013



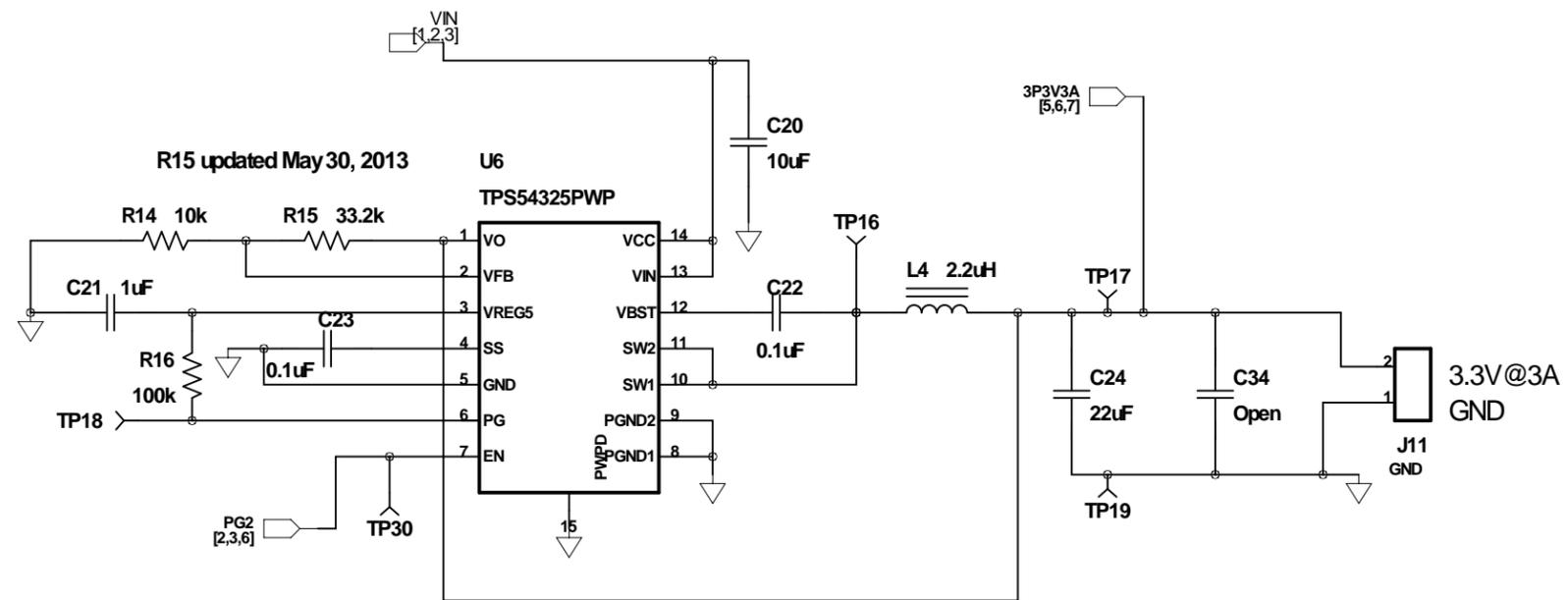
1-2 = 13.7k : Vout = 1.8V
 3-4 = 22.6k : Vout = 2.5V
 5-6 = 33.2k : Vout = 3.3V

R12, R13 updated may 30, 2013

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|-------------------------------|---------------------------|----------|
| Texas Instruments | | |
| Title Power for Zynq-7000 | | |
| Size B | Number PMP8251 | Rev B |
| Date 6/4/2013 | Drawn by Sureena Gupta | |
| Filename PMP8251_Rev_B.sch | Sheet 3 | of 7 |

Engineer Sureena Gupta

6/4/2013

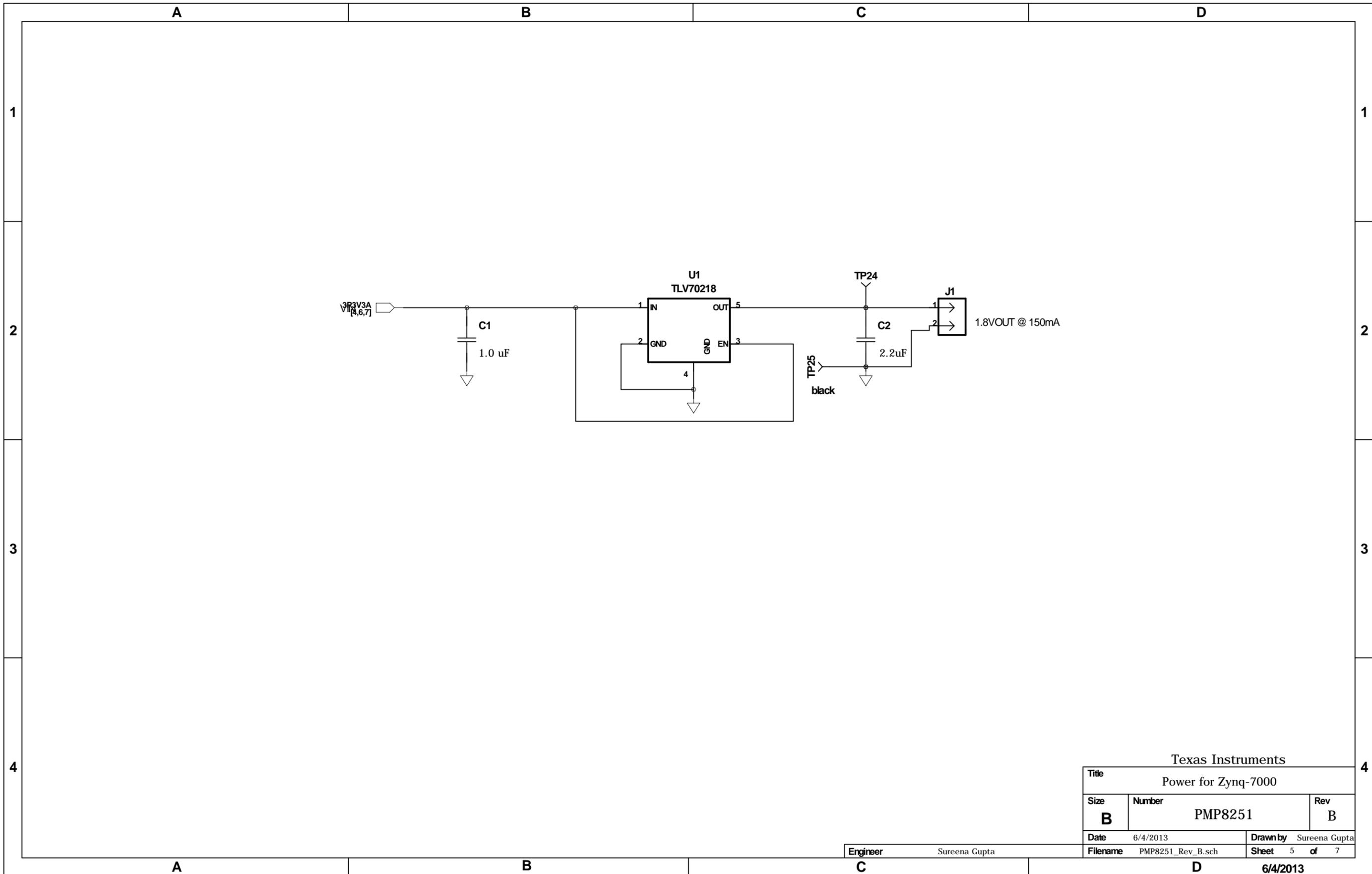


Texas Instruments

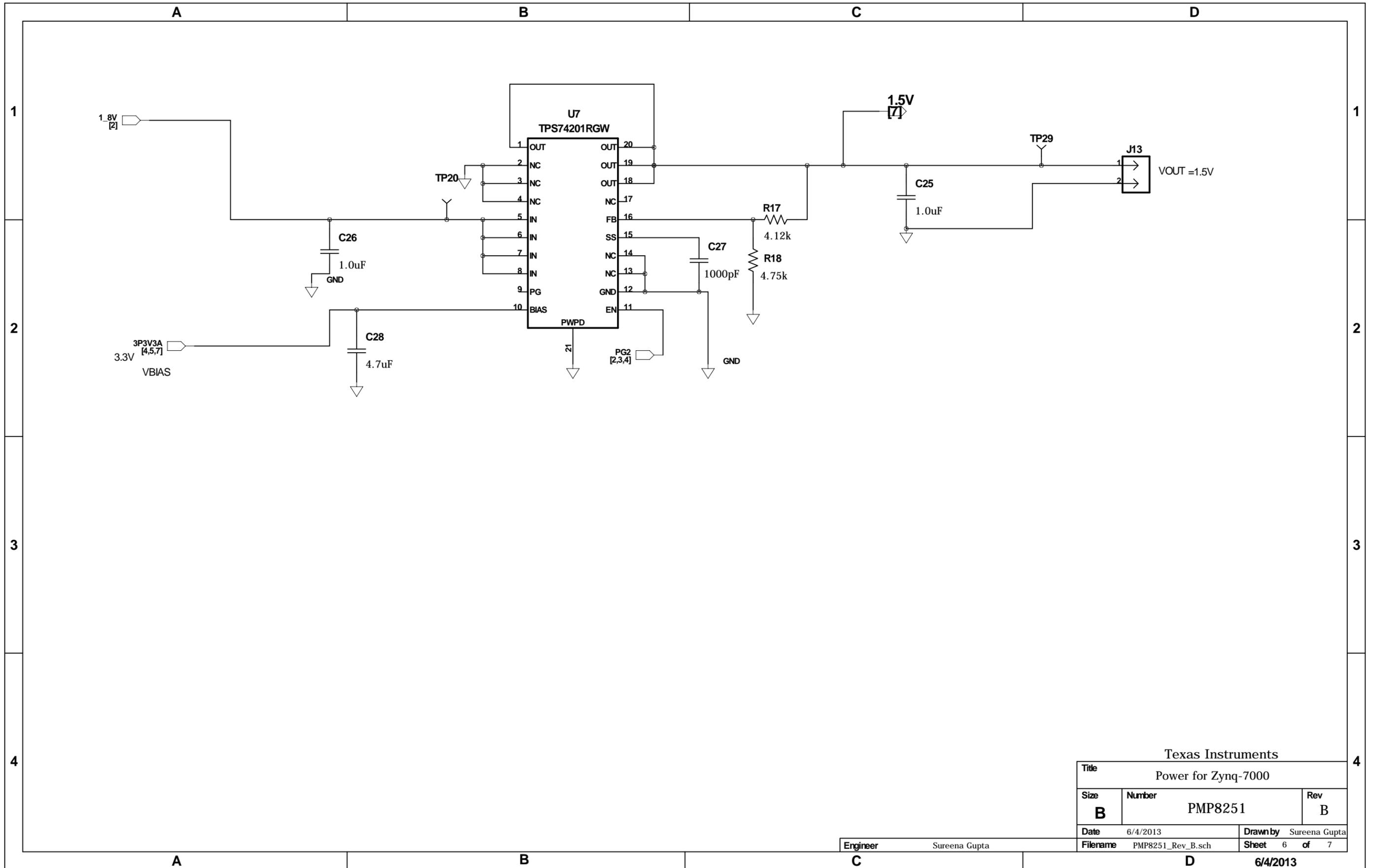
| | | | | | |
|----------|-------------------|----------|---------------------|----|---|
| Title | | | Power for Zynq-7000 | | |
| Size | Number | Rev | | | |
| B | PMP8251 | B | | | |
| Date | 6/4/2013 | Drawn by | Sureena Gupta | | |
| Filename | PMP8251_Rev_B.sch | Sheet | 4 | of | 7 |

Engineer Sureena Gupta

6/4/2013



| | | |
|------------------------------|-------------------------------|-----------------|
| Texas Instruments | | |
| Title Power for Zynq-7000 | | |
| Size B | Number PMP8251 | Rev B |
| Date 6/4/2013 | Drawn by Sureena Gupta | |
| Engineer Sureena Gupta | Filename PMP8251_Rev_B.sch | Sheet 5 of 7 |
| 6/4/2013 | | |



Texas Instruments

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|---------------------|-------------------|------------------------|
| Title | | |
| Power for Zynq-7000 | | |
| Size | Number | Rev |
| B | PMP8251 | B |
| Date | 6/4/2013 | Drawn by Sureena Gupta |
| Filename | PMP8251_Rev_B.sch | Sheet 6 of 7 |

Engineer Sureena Gupta

6/4/2013

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